



PTO/SB/08A (10-01)

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Substitute for form 1449A/PTO				Complete if Known	
<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b> <i>(use as many sheets as necessary)</i>				Application Number	10/763,859
				Filing Date	01/23/2004
				First Named Inventor	Tae Heon Lee
				Art Unit	2811
				Examiner Name	Unknown
Sheet	1	of	1	Attorney Docket Number	AMKOR-053G

FOREIGN PATENT DOCUMENTS					
Examiner Initials*	Cite No. 1	Foreign Patent Document	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		Country Code 3 - Number <sup>4</sup> - Kind Code <sup>5</sup> (if known)			
PC		200204397	08/02/2002	JAPAN	
		0049944	06/26/2002	KOREA	
		2001060648	03/06/2001	JAPAN	
		556398	10/29/2000	JAPAN	
		EP1032037	08/30/2000	EU PAT. OFFICE	
		00150765	05/30/2000	JAPAN	
		EP098968	03/29/2000	EU PAT. OFFICE	
		9967821	12/29/1999	PCT	
		9956316	11/04/1999	PCT	
PC		EP0936671	08/18/1999	EU PAT. OFFICE	

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		Country Code <sup>3</sup> - Number <sup>4</sup> - Kind Code <sup>5</sup> (if known)				
PC		100220154	06/18/1999	KOREA		
		10256240	09/25/1998	JAPAN		
		10199934	07/31/1998	JAPAN		
		10163401	06/19/1998	JAPAN		
		EP0844665	05/27/1998	EU PAT. OFFICE		
		10022447	JAN-98	JAPAN		
		9293822	11/11/1997	JAPAN		
		9772358	11/07/1997	KOREA		
		EP0794572A2	10/09/1997	EU PAT. OFFICE		
PC		DE19734794A1	08/11/1997	GERMANY		

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		Country Code <sup>3</sup> -Number <sup>4</sup> -Kind Code <sup>5</sup> (if known)			
PC		992775	04/04/1997	JAPAN	
		98205	01/10/1997	JAPAN	
		98206	01/10/1997	JAPAN	
		98207	01/10/1997	JAPAN	
		8306853	11/22/1996	JAPAN	
		8222682	08/30/1996	JAPAN	
		8125066	05/17/1996	JAPAN	
		8083877	03/26/1996	JAPAN	
		864634	03/08/1996	JAPAN	
PC		EP0720225	03/07/1996	EU PAT. OFFICE	

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		Country Code <sup>3</sup> -Number <sup>4</sup> -Kind Code <sup>5</sup> (if known)				
PC		EP0720234	03/07/1996	EU PAT. OFFICE		
		7312405	11/28/1995	JAPAN		
		7297344	11/1995	JAPAN		
		6260532	09/16/1994	JAPAN		
		6140563	05/20/1994	JAPAN		
		692076	04/05/1994	JAPAN		
		941979	01/03/1994	KOREA		
		5283460	10/29/1993	JAPAN		
		5166992	07/1993	JAPAN		
PC		5129473	05/25/1993	JAPAN		

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<p>Art Unit</p>		<p>2811</p>			
<p>Examiner Name</p>		<p>Unknown</p>			
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		Country Code <sup>3</sup> - Number <sup>4</sup> - Kind Code <sup>5</sup> (if known)				
PC		4098864	09-1992	JAPAN		
		EP0459493	12/04/1991	EU PAT. OFFICE		
		3177060	08/01/1991	JAPAN		
		EP0393997	10/24/1990	EU PAT. OFFICE		
		1251747	10/06/1989	JAPAN		
		1205544	08/1989	JAPAN		
		1175250	07/11/1989	JAPAN		
		1106456	04/24/1989	JAPAN		
		64054749	03/02/1989	JAPAN		
PC		63316470	12/23/1988	JAPAN		

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<p>Art Unit</p>		<p>2811</p>			
<p>Examiner Name</p>		<p>Unknown</p>			
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<p>1</p>		<p>Attorney Docket Number</p>		<p>AMKOR-053G</p>	

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		Country Code <sup>3</sup> - Number <sup>4</sup> - Kind Code <sup>5</sup> (if known)			
PC		63249345	10/17/1988	JAPAN	
		63233555	09/29/1988	JAPAN	
		63205935	08/25/1988	JAPAN	
		63067762	03/26/1988	JAPAN	
		629639	01/17/1987	JAPAN	
		6139555	02/25/1986	JAPAN	
		60231349	11/16/1985	JAPAN	
		60195957	10/04/1985	JAPAN	
		60116239	08/06/1985	JAPAN	
PC		60010756	01/19/1985	JAPAN	

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Electronic Version v18

Stylesheet Version v18.0

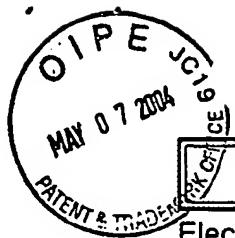
Title of Invention	SEMICONDUCTOR PACKAGE HAVING REDUCED THICKNESS						
Application Number:	10/763859 						
Confirmation Number:	8528						
First Named Applicant:	TAE LEE						
Attorney Docket Number:	AMKOR053G						
Art Unit:	2811						
Search string:	( 5886398 or 5894108 or 5897339 or 5900676 or 5903049 or 5903050 or 5909053 or 5915998 or 5917242 or 5939779 or 5942794 or 5951305 or 5959356 or 5969426 or 5973388 or 5976912 or 5977613 or 5977615 or 5977630 or 5981314 or 5986333 or 5986885 or 6001671 or 6013947 or 6018189 or 6020625 or 6025640 or 6031279 or 6034423 or RE36613 or 6040626 or 6043430 or 6060768 or 6060769 or 6072228 or 6075284 or 6081029 or 6084310 or 6087715 or 6087722 or 6100594 or 6114752 or 6113474 or 6118174 or 6118184 or 6130115 or 6130473 or RE36907 or 6133623 or 6140154 ).pn.						
<b>US Patent Documents</b>							
Note: Applicant is not required to submit a paper copy of cited US Patent Documents							
init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
PC	1	5886398	1999-03-23	Low et al.			
	2	5894108	1999-04-13	Mostafazadeh et al.			
	3	5897339	1999-04-27	Song et al.			
	4	5900676	1999-05-04	Kweon et al.			
	5	5903049	1999-05-11	Mori			
	6	5903050	1999-05-11	Thurairajaratnam et al.			
	7	5909053	1999-06-01	Fukase et al.			
	8	5915998	1999-06-29	Stidham et al.			
PC	9	5917242	1999-06-29	Ball			

PC	10	5939779	1999-08-17	Kim
	11	5942794	1999-08-24	Okumura et al.
	12	5951305	1999-09-14	Haba
	13	5959356	1999-09-28	Oh
	14	5969426	1999-10-19	Baba et al.
	15	5973388	1999-10-26	Chew et al.
	16	5976912	1999-11-02	Fukutomi et al.
	17	5977613	1999-11-02	Takata et al.
	18	5977615	1999-11-02	Yamaguchi et al.
	19	5977630	1999-11-02	Woodworth et al.
	20	5981314	1999-11-09	Glenn et al.
	21	5986333	1999-11-16	Nakamura
	22	5986885	1999-11-16	Wyland
	23	6001671	1999-12-14	Fjelstad
	24	6013947	2000-01-11	Lim
	25	6018189	2000-01-25	Mizuno
	26	6020625	2000-02-01	Qin et al.
	27	6025640	2000-02-15	Yagi et al.
	28	6031279	2000-02-29	Lenz
	29	6034423	2000-03-07	Mostafazadeh et al.
	30	RE36613	2000-03-14	Ball
	31	6040626	2000-03-21	Cheah et al.
	32	6043430	2000-03-28	Chun
	33	6060768	2000-05-09	Hayashida et al.
	34	6060769	2000-05-09	Wark
	35	6072228	2000-06-06	Hinkle et al.
	36	6075284	2000-06-13	Choi et al.
	37	6081029	2000-06-27	Yamaguchi
	38	6084310	2000-07-04	Mizuno et al.
	39	6087715	2000-07-11	Sawada et al.
	40	6087722	2000-07-11	Lee et al.
	41	6100594	2000-08-08	Fukui et al.
	42	6114752	2000-09-05	Huang et al.
	43	6113474	2000-09-05	Costantini et al.
	44	6118174	2000-09-12	Kim
PC	45	6118184	2000-09-12	Ishio et al.

PL	46	6130115	2000-10-10	Okumura et al.
PL	47	6130473	2000-10-10	Mostafazadeh et al.
PL	48	RE36907	2000-10-10	Templeton, Jr. et al.
PL	49	6133623	2000-10-17	Otsuki et al.
PL	50	6140154	2000-10-31	Hinkle et al.

Signature

Examiner Name	Date
PHAT X. CAO	6/7/05



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Title of Invention	SEMICONDUCTOR PACKAGE HAVING REDUCED THICKNESS						
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Confirmation Number:	8528						
First Named Applicant:	TAE LEE						
Attorney Docket Number:	AMKOR053G						
Art Unit:	2811						
Search string:	( 5608265 or 5608267 or 5625222 or 5633528 or 5639990 or 5640047 or 5641997 or 5643433 or 5644169 or 5646831 or 5650663 or 5661088 or 5665996 or 5673479 or 5683806 or 5689135 or 5696666 or 5701034 or 5703407 or 5710064 or 5724233 or 5723899 or 5726493 or 5736432 or 5745984 or 5753532 or 5753977 or 5766972 or 5770888 or 5776798 or 5783861 or 5801440 or 5814877 or 5814881 or 5814883 or 5814884 or 5817540 or 5818105 or 5821457 or 5821615 or 5834830 or 5835988 or 5844306 or 5856911 or 5859471 or 5866939 or 5871782 or 5874784 or 5877043 or 5886397 ).pn.						
<b>US Patent Documents</b>							
Note: Applicant is not required to submit a paper copy of cited US Patent Documents							
init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
PC	1	5608265	1997-03-04	Kitano et al.			
	2	5608267	1997-03-04	Mahulikar et al.			
	3	5625222	1997-04-29	Yoneda et al.			
	4	5633528	1997-05-27	Abbott et al.			
	5	5639990	1997-06-17	Nishihara et al.			
	6	5640047	1997-06-17	Nakashima			
	7	5641997	1997-06-24	Ohta et al.			
	8	5643433	1997-07-01	Fukase et al.			
PC	9	5644169	1997-07-01	Chun			

PC	10	5646831	1997-07-08	Manteghi
	11	5650663	1997-07-22	Parthasaranthi
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Title of Invention	SEMICONDUCTOR PACKAGE HAVING REDUCED THICKNESS						
Application Number:	10/763859 						
Confirmation Number:	8528						
First Named Applicant:	TAE LEE						
Attorney Docket Number:	AMKOR053G						
Art Unit:	2811						
Search string:	( 5216278 or 5218231 or 5221642 or 5250841 or 5252853 or 5258094 or 5266834 or 5273938 or 5277972 or 5278446 or 5279029 or 5281849 or 5294897 or 5327008 or 5332864 or 5335771 or 5336931 or 5343076 or 5358905 or 5365106 or 5381042 or 5391439 or 5406124 or 5410180 or 5414299 or 5417905 or 5424576 or 5428248 or 5435057 or 5444301 or 5452511 or 5454905 or 5474958 or 5484274 or 5493151 or 5508556 or 5517056 or 5521429 or 5528076 or 5534467 or 5539251 or 5543657 or 5544412 or 5545923 or 5581122 or 5592019 or 5592025 or 5594274 or 5595934 or 5604376 ).pn.						
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Title of Invention	SEMICONDUCTOR PACKAGE HAVING REDUCED THICKNESS
Application Number:	10/763859
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First Named Applicant:	TAE LEE
Attorney Docket Number:	AMKOR053G
Art Unit:	2811
Search string:	( 2596993 or 3435815 or 3734660 or 3838984 or 4054238 or 4189342 or 4258381 or 4289922 or 4301464 or 4332537 or 4417266 or 4451224 or 4530152 or 4541003 or 4646710 or 4707724 or 4727633 or 4737839 or 4756080 or 4812896 or 4862245 or 4862246 or 4907067 or 4920074 or 4935803 or 4942454 or 4987475 or 5018003 or 5029386 or 5041902 or 5057900 or 5059379 or 5065223 or 5070039 or 5087961 or 5091341 or 5096852 or 5118298 or 5122860 or 5134773 or 5151039 or 5157475 or 5157480 or 5168368 or 5172213 or 5172214 or 5175060 or 5200362 or 5200809 or 5214845 or 20010008305 or 20010014538 or 20010011654 or 20020024122 or 20020027297 or 20020140061 or 20020140068 or 20020163015 or 20030030131 or 20030073265 ).pn.

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<b>US Patent Documents</b>					
Note: Applicant is not required to submit a paper copy of cited US Patent Documents					
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